

満里澤 宏昭  
昭



Development of I...



近年の...  
高度情報化...

アルミ基板を用いた、基板材質とテクスチャー加工

細孔の形成は、アルミ基板に

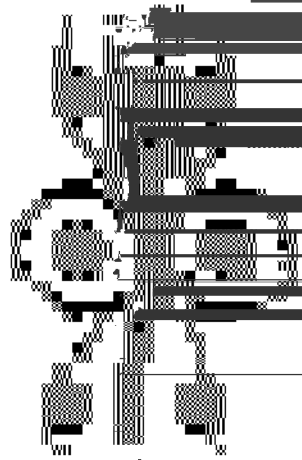
(1) アルミ基板

基板は、アルミ合金基板に

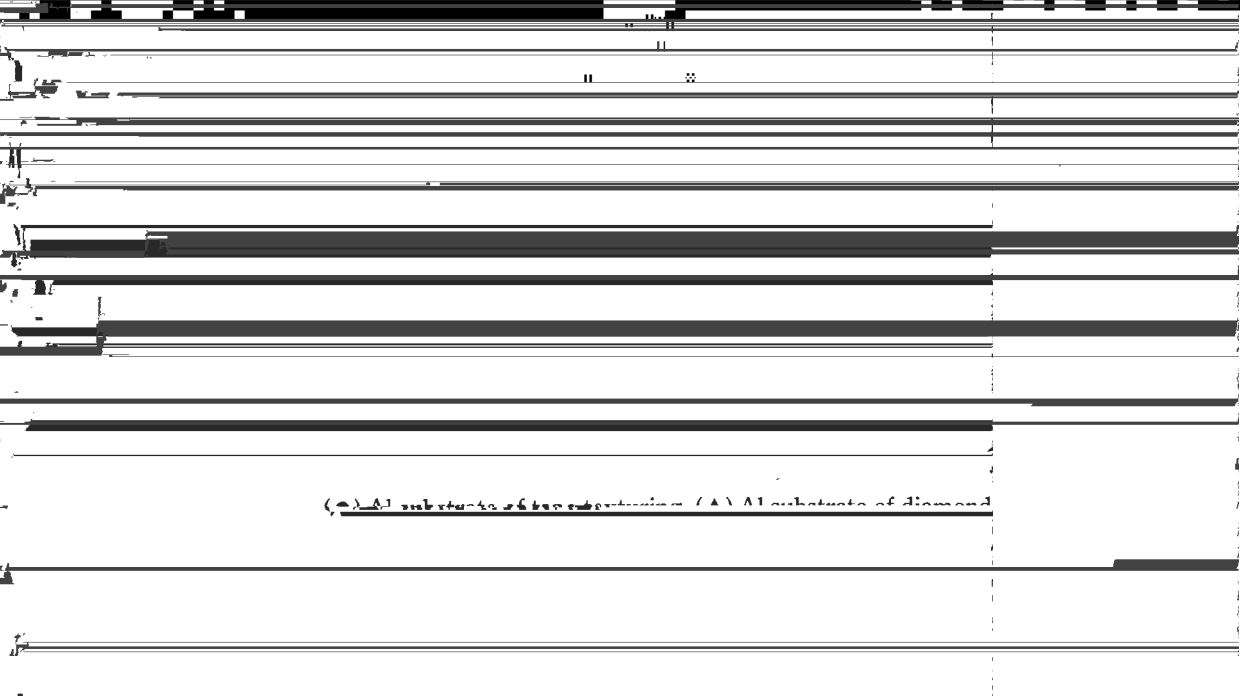
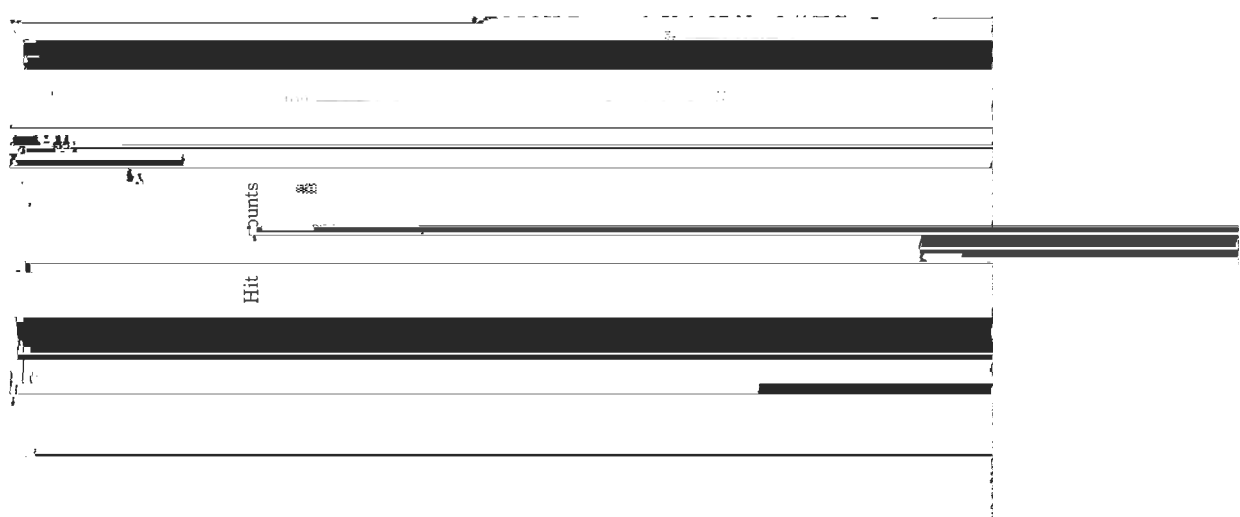
Table 3 Slurry texturing conditions

Tape feed speed. 10~20 mm/min

Out: 0.95~1.35 kg







(●) Al substrate of 600 substrate (▲) Al substrate of diamond

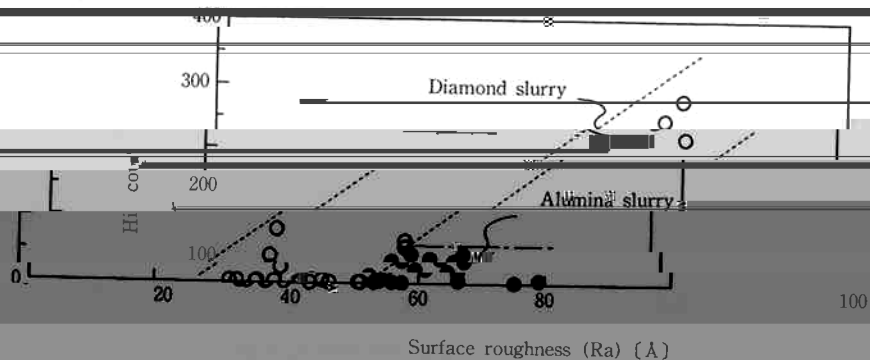


Fig. 5 Relationship between hit counts and surface roughness

Maximum friction coefficient

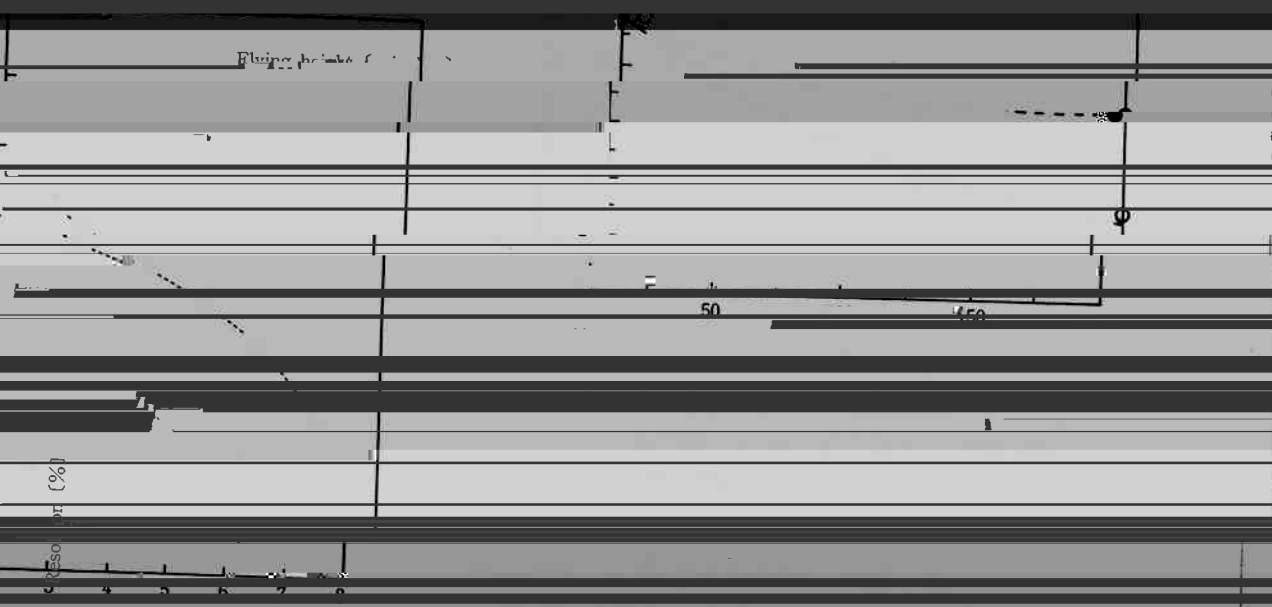
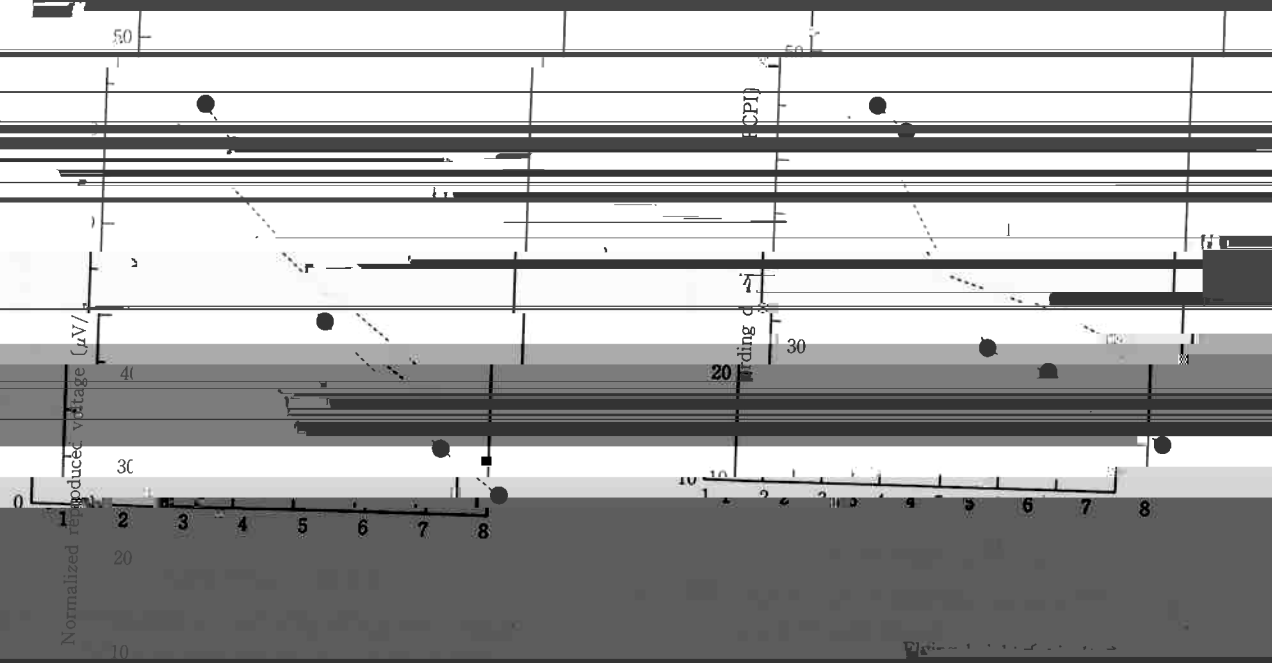
0.36  
0.17

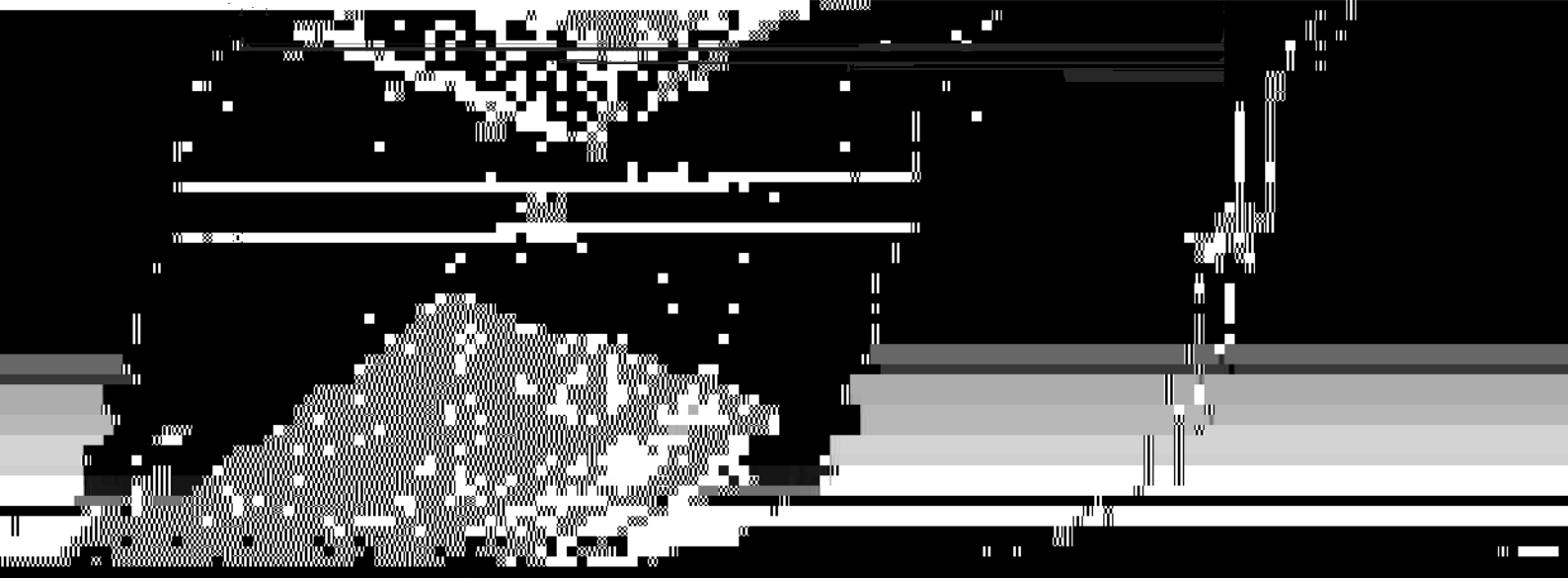
ラリー法に分類した示す 同図の結果より 4/1000

ラリー法とアルミテスラリー法の Ra 比較表を次に示す

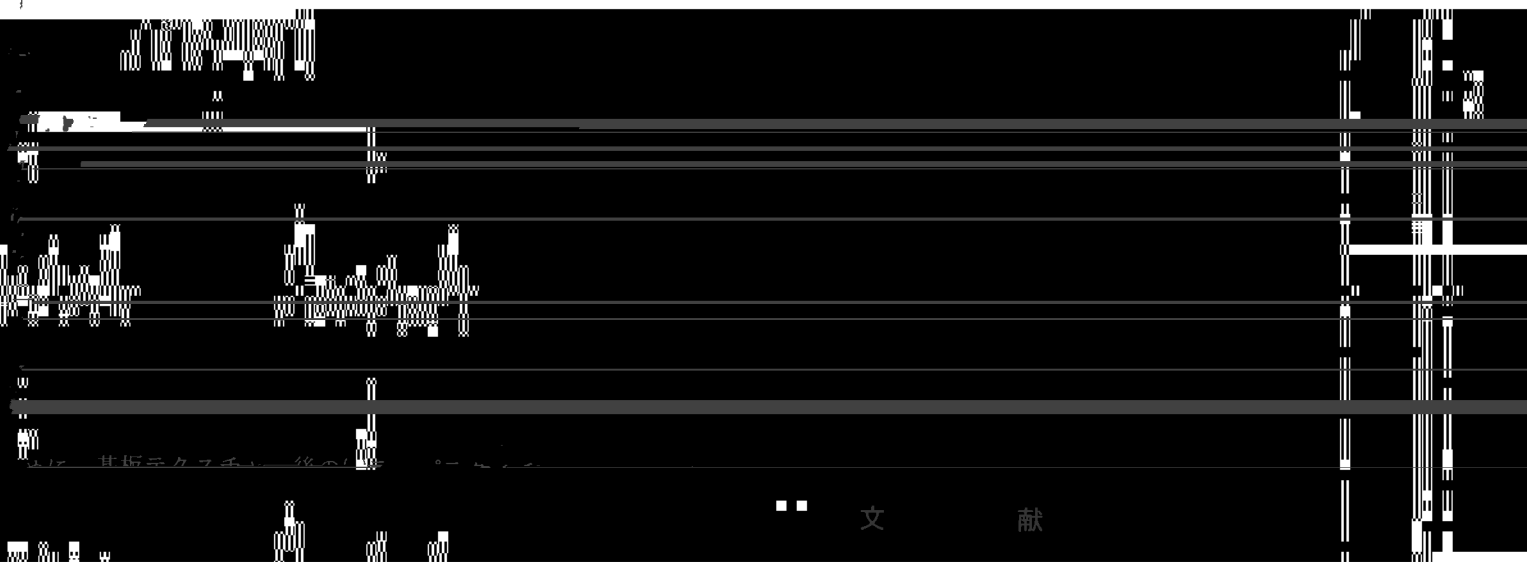
of alumina slurry tested by the same method as that of diamond slurry





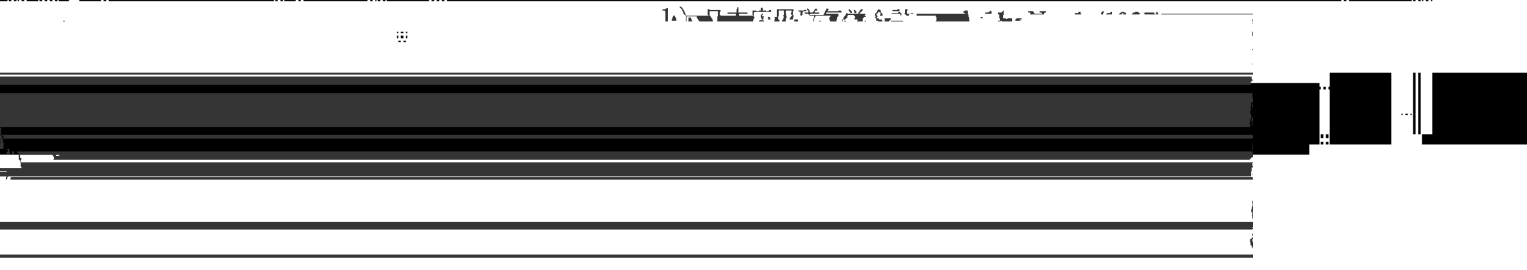




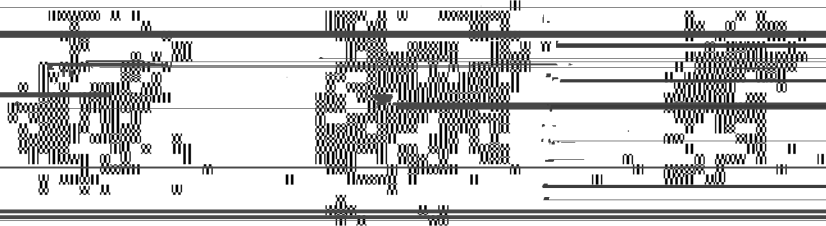


文 献

1. 日本学術振興会 研究費助成事業 1990年度



57 14921



(1981)